

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Wen-Ching Chen

Group

:

Serial No:

10/662,433

Art Unit # 2878

Filed:

16 September 2003

Examiner:

Title:

CHIP SCALE PACKAGE

D.J. Williams

STRUCTURE FOR AN IMAGE

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Responsive to the Notice of Non-Compliant Amendment dated 19 April 2006 please amend the above-referenced Patent Application as follows:

Amendments to the Claims are reflected in the Corrected Listing of Claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper